# **Bridge Rectifiers** (Glass Passivated)

# **GBPC 12, 15, 25, 35 SERIES**

#### **Features**

- Integrally Molded Heat-Sink Provided Very Low Thermal Resistance for Maximum Heat Dissipation
- Surge Overload Ratings from 300 A to 400 A
- Isolated Voltage from Case to Lead over 2500 V
- UL Certified, UL #E258596
- Terminals Finish Material
  - Silver (Solderable per MIL-STD-202, Method 208 for the wire type GBPC-W package)
  - Nickel for GBPC package
- Mounting Torque: 20 in-lbs Maximum
- These are Pb-Free Devices

#### Suffix "W"

• Wire Lead Structure



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GBPC CASE 160AD

GBPC-W CASE 160AD

#### **PIN ASSIGNMENT**





**GBPC** 

GBPC-W

#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 4 of this data sheet.

#### **SPECIFICATIONS**

## **ABSOLUTE MAXIMUM RATINGS** ( $T_A = 25^{\circ}C$ , unless otherwise specified.) (Note 1)

				Value						
Symbol	Para	meter	005	01	02	04	06	08	10	Units
V <sub>RRM</sub>	Maximum Repetitive Reverse Voltage		50	100	200	400	600	800	1000	V
V <sub>RMS</sub>	Maximum RMS Bridge Input Voltage		35	70	140	280	420	560	700	V
V <sub>R</sub>	DC Reverse Voltage (Rated V <sub>R</sub> )		50	100	200	400	600	800	1000	V
I <sub>F(AV)</sub>	Average Rectified	GBPC12		12						Α
	Forward Current at $T_C = 55^{\circ}C$	GBPC15		15						
		GBPC25		25						
		GBPC35				35				
I <sub>FSM</sub>	Non-Repetitive Peak Forward Surge Current	GBPC12, 15, 25		300				Α		
	8.3 ms Single Half-Sine-Wave	GBPC35				400				Α
T <sub>STG</sub>	Storage Temperature Range			-55 to +150				°C		
TJ	Operating Junction Temperature			-55 to +150			°C			

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. These ratings are limiting values above which the serviceability of any semiconductor device may by impaired.

## THERMAL CHARACTERISTICS (T<sub>A</sub> = 25°C, unless otherwise specified.)

Symbol	Parameter	Value	Unit
$P_{D}$	Power Dissipation	83.3	W
$R_{ heta JC}$	Thermal Resistance, Junction to Case (Note 2)	1.5	°C/W

<sup>2.</sup> With Heatsink.

# **ELECTRICAL CHARACTERISTICS** ( $T_A = 25$ °C, unless otherwise specified.)

Symbol	Parameter	Test Conditions		Value	Unit
V <sub>F</sub>	Forward Voltage Drop, per bridge	6.0 A	GBPC12	1.1 (Max)	V
		7.5 A	GBPC15		
		12.5 A	GBPC25		
		17.5 A	GBPC35		
I <sub>R</sub>	Reverse Current, per element at Rated V <sub>R</sub>	T <sub>A</sub> = 25°C		5.0 (Max)	μΑ
		T <sub>A</sub> = 125°C		500 (Max)	μΑ
I <sup>2</sup> t	Rating for Fusing t < 8.35 ms	GBPC12, 15, 25		375	A <sup>2</sup> Sec
		GBPC35		660	A <sup>2</sup> Sec
C <sub>T</sub>	Total Capacitance, per leg V <sub>R</sub> = 4.0 V, f = 1.0 MHz	GBPC12, 15, 25		180	pF
				200	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### TYPICAL PERFORMANCE CHARACTERISTICS

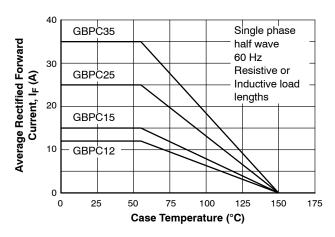


Figure 1. Forward Current Derating Curve

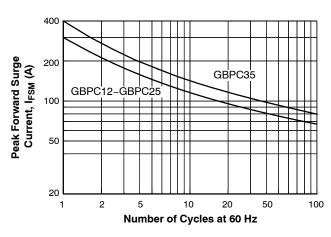


Figure 2. Non-Repetitive Surge Current

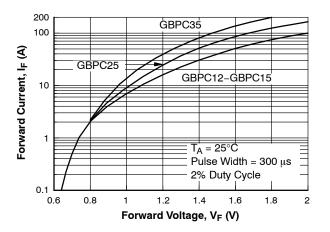


Figure 3. Forward Voltage Characteristics

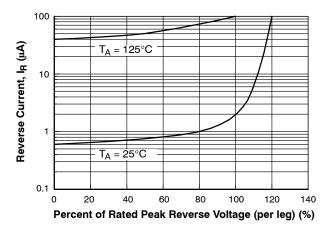


Figure 4. Reverse Current vs. Reverse Voltage

## **ORDERING INFORMATION**

Part Number	Marking	Package	Packing Method
GBPC12005	GBPC12005	GBPC 4L	Bulk
GBPC1201	GBPC1201	(Pb-Free)	
GBPC1202	GBPC1202		
GBPC1204	GBPC1204		
GBPC1206	GBPC1206		
GBPC1208	GBPC1208		
GBPC1210	GBPC1210		
GBPC15005	GBPC15005		
GBPC1501	GBPC1501		
GBPC1502	GBPC1502		
GBPC1504	GBPC1504		
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GBPC1508	GBPC1508		
GBPC1510	GBPC1510		
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GBPC2504	GBPC2504		
GBPC2506	GBPC2506		
GBPC2508	GBPC2508		
GBPC2510	GBPC2510		
GBPC35005	GBPC35005		
GBPC3501	GBPC3501		
GBPC3502	GBPC3502		
GBPC3504	GBPC3504		
GBPC3506	GBPC3506		
GBPC3508	GBPC3508		
GBPC3510	GBPC3510		
GBPC1201W	GBPC1201W	GBPC-W 4L	
GBPC1202W	GBPC1202W	(Pb-Free)	
GBPC1204W	GBPC1204W		
GBPC1206W	GBPC1206W		
GBPC1208W	GBPC1208W		
GBPC1210W	GBPC1210W		
GBPC15005W	GBPC15005W		
GBPC1501W	GBPC1501W		
GBPC1502W	GBPC1502W	<u> </u>	
GBPC1504W	GBPC1504W		
GBPC1506W	GBPC1506W		
GBPC1508W	GBPC1508W	1	

# **ORDERING INFORMATION** (continued)

Part Number	Marking	Package	Packing Method		
GBPC1510W	GBPC1510W	GBPC-W 4L	Bulk		
GBPC25005W	GBPC25005W	(Pb-Free)			
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GBPC2502W	GBPC2502W				
GBPC2504W	GBPC2504W				
GBPC2506W	GBPC2506W				
GBPC2508W	GBPC2508W				
GBPC2510W	GBPC2510W				
GBPC35005W	GBPC35005W				
GBPC3501W	GBPC3501W				
GBPC3502W	GBPC3502W				
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GBPC3506W	GBPC3506W				
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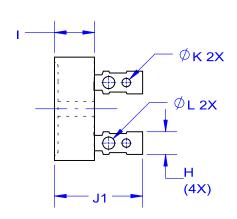


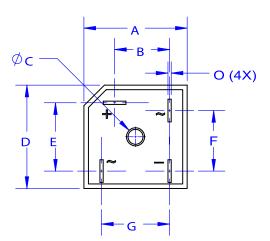
## GBPC4 28.75X28.75

CASE 160AD ISSUE A

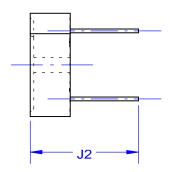
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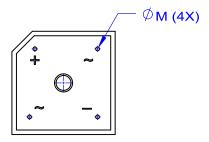
# **GBPC STYLE**





# **GBPC-W STYLE**





#### NOTES:

- A. THIS PACKAGE DOES NOT CONFORM TO ANY STANDARDS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.

DIM	MILLIMETERS				
DIM	MIN	NOM	MAX		
Α	28.50	28.75	29.00		
В	13.325	14.375	15.425		
C	5.08	5.335	5.59		
D	28.50	28.75	29.00		
Е	15.50	16.55	17.60		
F	13.30	14.30	15.30		
G	17.10	18.10	19.10		
Н	~	?	6.35		
I	10.97	11.10	11.23		
J1	21.50	23.00	24.50		
J2	30.50 ~ ~				
Øκ	2.39 BSC				
ØL	3.41 BSC				
Øм	0.97 1.02 1.07				
0	0.71	71 0.81 0.91			

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